

Surface Mount Fast Switching Rectifier

RS1A - RS1K

Vishaymas General Semiconductor



DO-214AC (SMA)

PRIMARY CHARACTERISTICS	
$I_{F(AV)}$	1.0 A
V_{RRM}	50 V, 100 V, 200 V, 400 V, 600 V, 800 V
I_{FSM}	30 A
t_{rr}	150 ns, 250 ns, 500 ns
V_F	1.3 V
$T_J \text{ max.}$	150 °C
Package	DO-214AC (SMA)
Diode variation	Single die

FEATURES

- Low profile package
- Ideal for automated placement
- Glass passivated pellet chip junction
- Fast switching for high efficiency
- High forward surge capability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Material categorization: for definitions of compliance please see www.vishaymas.com

TYPICAL APPLICATIONS

For use in fast switching rectification of power supply, inverters, converters, and freewheeling diodes for consumer, and telecommunication.

MECHANICAL DATA

Case: DO-214AC (SMA)

Molding compound meets UL 94 V-0 flammability rating
Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade

Terminals: Matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 suffix meets JESD 201 class 2 whisker test

Polarity: Color band denotes cathode end

MAXIMUM RATINGS ($T_A = 25\text{ °C}$ unless otherwise noted)								
PARAMETER	SYMBOL	RS1A	RS1B	RS1D	RS1G	RS1J	RS1K	UNIT
Device marking code		RA	RB	RD	RG	RJ	RK	
Maximum repetitive peak reverse voltage	V_{RRM}	50	100	200	400	600	800	V
Maximum RMS voltage	V_{RMS}	35	70	140	280	420	500	V
Maximum DC blocking voltage	V_{DC}	50	100	200	400	600	800	V
Maximum average forward rectified current at $T_L = 90\text{ °C}$	$I_{F(AV)}$	1.0						A
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	I_{FSM}	30						A
Operating junction and storage temperature range	T_J, T_{STG}	-55 to +150						°C

ELECTRICAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)										
PARAMETER	TEST CONDITIONS		SYMBOL	RS1A	RS1B	RS1D	RS1G	RS1J	RS1K	UNIT
Maximum instantaneous forward voltage	1.0 A		V _F	1.3						V
Maximum DC reverse current at rated DC blocking voltage		T _A = 25 °C	I _R	5.0						μA
		T _A = 125 °C		50						
Maximum reverse recovery time	I _F = 0.5 A, I _R = 1.0 A, I _{rr} = 0.25 A		t _{rr}	150				250	500	ns
Typical junction capacitance	4.0 V, 1 MHz		C _J	10				7.0		pF

THERMAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)								
PARAMETER	SYMBOL	RS1A	RS1B	RS1D	RS1G	RS1J	RS1K	UNIT
Typical thermal resistance	R _{θJA} ⁽¹⁾	105						°C/W
	R _{θJL} ⁽¹⁾	32						

Note

(1) Thermal resistance from junction to ambient and from junction to lead mounted on PCB with 0.2" x 0.2" (5.0 mm x 5.0 mm) copper pad areas

ORDERING INFORMATION (Example)				
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE
RS1J-M3/61T	0.064	61T	1800	7" diameter plastic tape and reel
RS1J-M3/5AT	0.064	5AT	7500	13" diameter plastic tape and reel

RATINGS AND CHARACTERISTICS CURVES ($T_A = 25^\circ\text{C}$ unless otherwise noted)

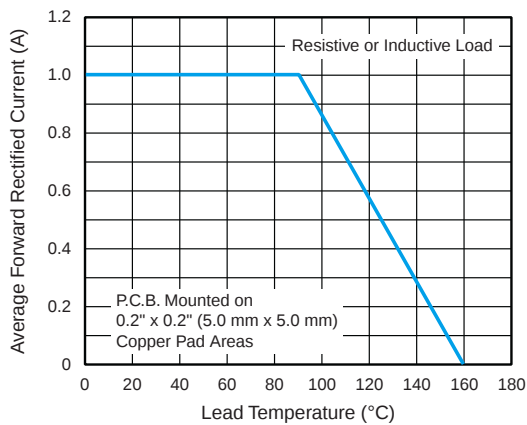


Fig. 1 - Forward Current Derating Curve

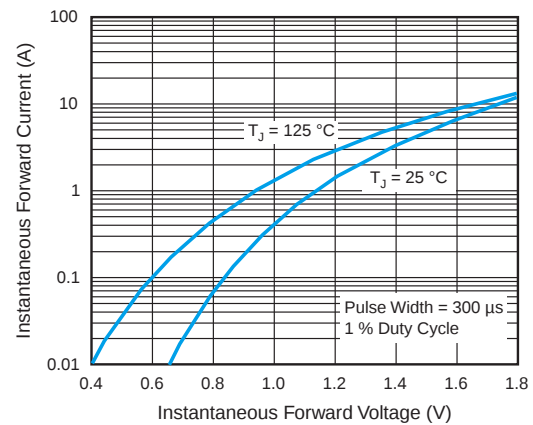


Fig. 3 - Typical Instantaneous Forward Characteristics

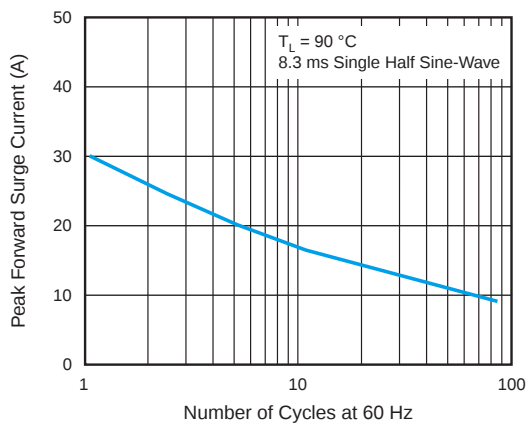


Fig. 2 - Maximum Non-Repetitive Peak Forward Surge Current

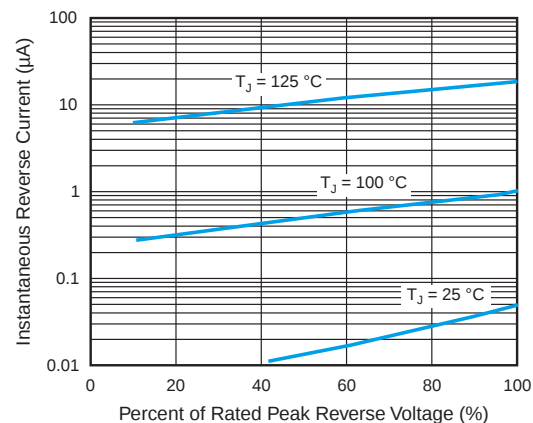


Fig. 4 - Typical Reverse Characteristics

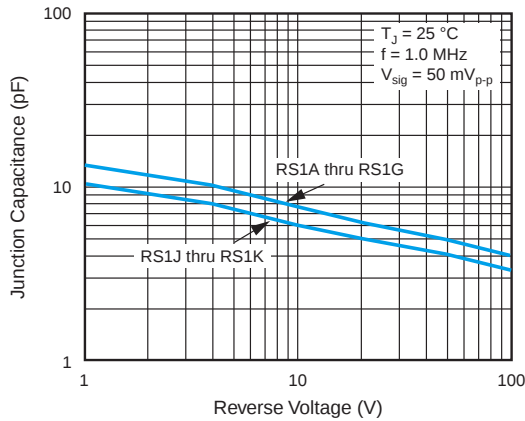


Fig. 5 - Typical Junction Capacitance

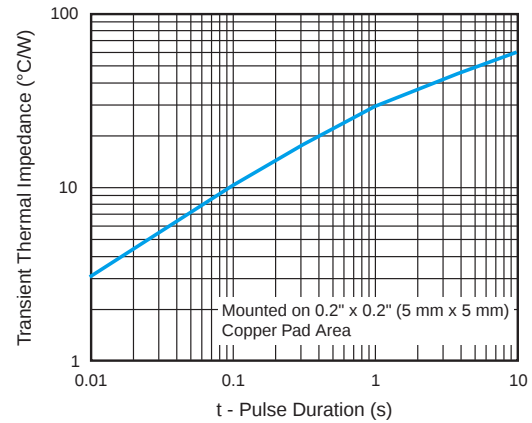
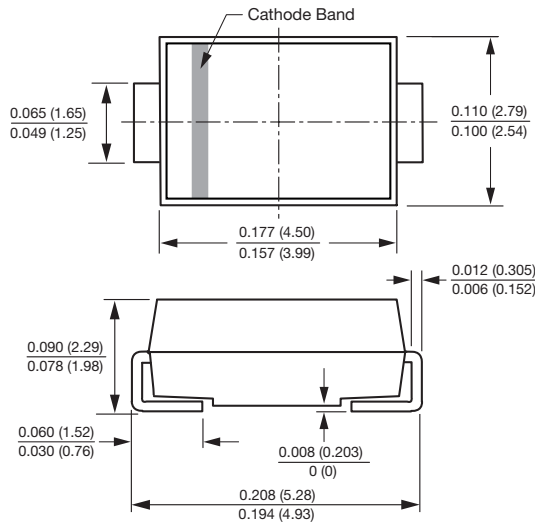


Fig. 6 - Typical Transient Thermal Impedance

PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

DO-214AC (SMA)



Mounting Pad Layout

